US00D854195S

(12) United States Design Patent

Lee et al.

(10) Patent No.: US D854,195 S
(45) Date of Patent: ** Jul. 16, 2019

(54) **LIGHT EMITTING DIODE PACKAGE**

(71) Applicant: **Genesis Photonics Inc.**, Tainan (TW)

(72) Inventors: **Hao-Chung Lee**, Taoyuan (TW); **Xun-Xain Zhan**, Tainan (TW); **Yu-Feng Lin**, Tainan (TW)

(73) Assignee: **Genesis Photonics Inc.**, Tainan (TW)

(**) Term: **15 Years**

(21) Appl. No.: **29/598,780**

(22) Filed: **Mar. 29, 2017**

(30) **Foreign Application Priority Data**

Sep. 29, 2016 (TW) 105305755

(51) **LOC (11) Cl.** **26-04**

(52) **U.S. Cl.**
USPC **D26/1**

(58) **Field of Classification Search**
USPC D26/1–4; D13/180
(Continued)

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Primary Examiner — Marcus A Jackson
(74) *Attorney, Agent, or Firm* — JCIPRNET

(57) **CLAIM**

The ornamental design for a light emitting diode package, as shown and described.

DESCRIPTION

FIG. **1** is a perspective view of a first embodiment of the light emitting diode package showing our new design;
FIG. **2** is a front view of the light emitting diode package of FIG. **1**;
FIG. **3** is a rear view of the light emitting diode package of FIG. **1**;
FIG. **4** is a left view of the light emitting diode package of FIG. **1**;
FIG. **5** is a right view of the light emitting diode package of FIG. **1**;
FIG. **6** is a top view of the light emitting diode package of FIG. **1**;
FIG. **7** is a bottom view of the light emitting diode package of FIG. **1**;
FIG. **8** is a perspective view of a second embodiment of the light emitting diode package showing our new design;
FIG. **9** is a front view of the light emitting diode package of FIG. **8**;
FIG. **10** is a rear view of the light emitting diode package of FIG. **8**;
FIG. **11** is a left view of the light emitting diode package of FIG. **8**;
FIG. **12** is a right view of the light emitting diode package of FIG. **8**;
FIG. **13** is a top view of the light emitting diode package of FIG. **8**;
FIG. **14** is a bottom view of the light emitting diode package of FIG. **8**;
FIG. **15** is a perspective view of a third embodiment of the light emitting diode package showing our new design;
FIG. **16** is a front view of the light emitting diode package of FIG. **15**;
FIG. **17** is a rear view of the light emitting diode package of FIG. **15**;
(Continued)

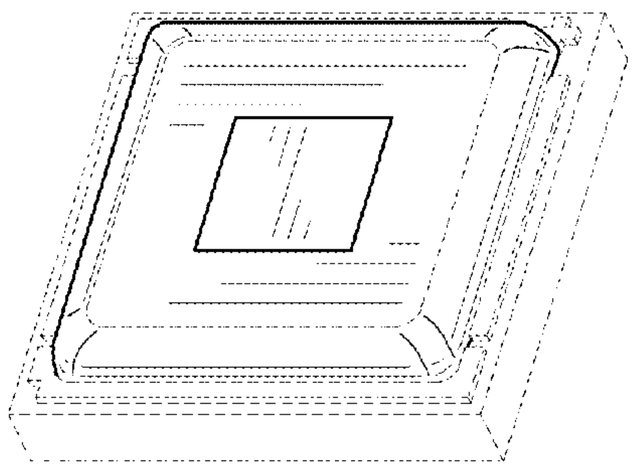

FIG. **18** is a left view of the light emitting diode package of FIG. **15**;
FIG. **19** is a right view of the light emitting diode package of FIG. **15**;
FIG. **20** is a top view of the light emitting diode package of FIG. **15**;
FIG. **21** is a bottom view of the light emitting diode package of FIG. **15**;
FIG. **22** is a perspective view of a fourth embodiment of the light emitting diode package showing our new design;
FIG. **23** is a front view of the light emitting diode package of FIG. **22**;
FIG. **24** is a rear view of the light emitting diode package of FIG. **22**;
FIG. **25** is a left view of the light emitting diode package of FIG. **22**;
FIG. **26** is a right view of the light emitting diode package of FIG. **22**;
FIG. **27** is a top view of the light emitting diode package of FIG. **22**;
FIG. **28** is a bottom view of the light emitting diode package of FIG. **22**;
FIG. **29** is a perspective view of a fifth embodiment of the light emitting diode package showing our new design;
FIG. **30** is a front view of the light emitting diode package of FIG. **29**;
FIG. **31** is a rear view of the light emitting diode package of FIG. **29**;
FIG. **32** is a left view of the light emitting diode package of FIG. **29**;
FIG. **33** is a right view of the light emitting diode package of FIG. **29**;
FIG. **34** is a top view of the light emitting diode package of FIG. **29**; and,
FIG. **35** is a bottom view of the light emitting diode package of FIG. **29**.
The broken lines in the drawings are included for the purpose of illustration and form no part of the claimed design.

1 Claim, 20 Drawing Sheets

(58) **Field of Classification Search**
CPC H01R 5/00; H01R 13/46; H01R 13/514; H01R 31/048; H01R 31/02; H01J 5/00; H01J 5/16; H01J 1/02; H01J 15/00; H01J 5/48; H01J 5/50; H01J 19/54; F21V 5/00; F21V 13/00; F21V 29/004
See application file for complete search history.

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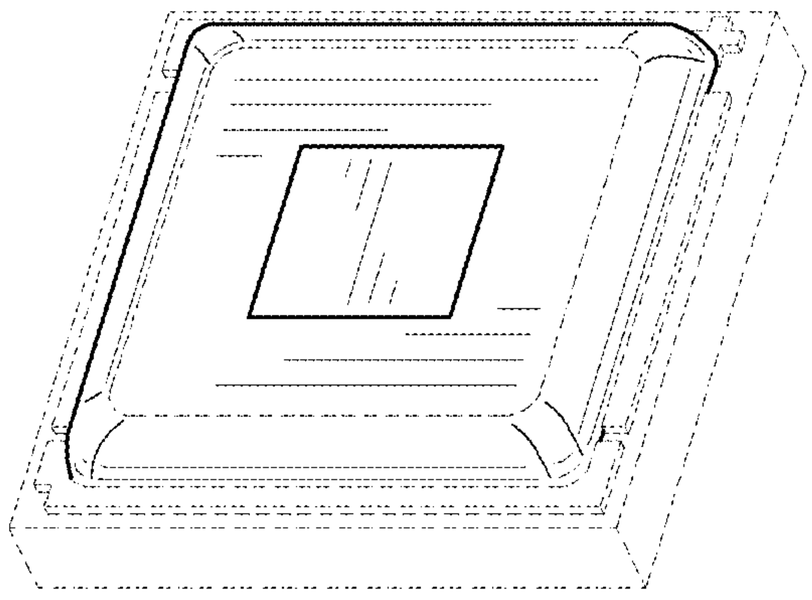


FIG. 1

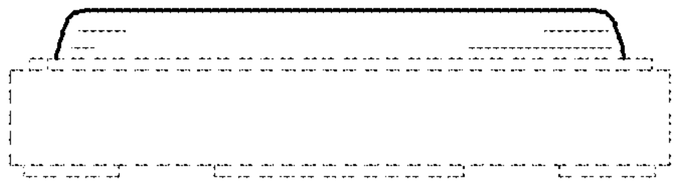


FIG. 2

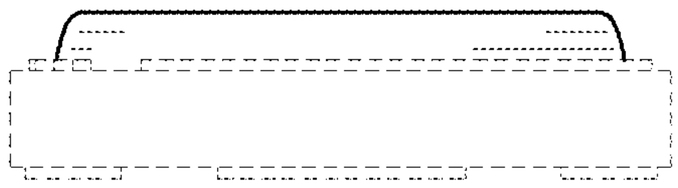


FIG. 3

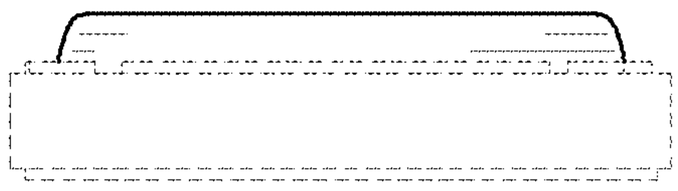


FIG. 4

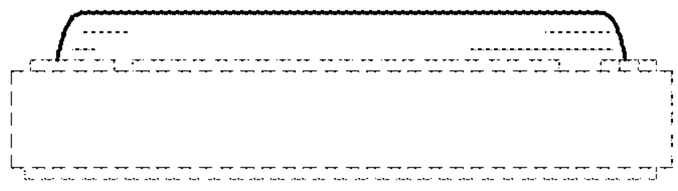


FIG. 5

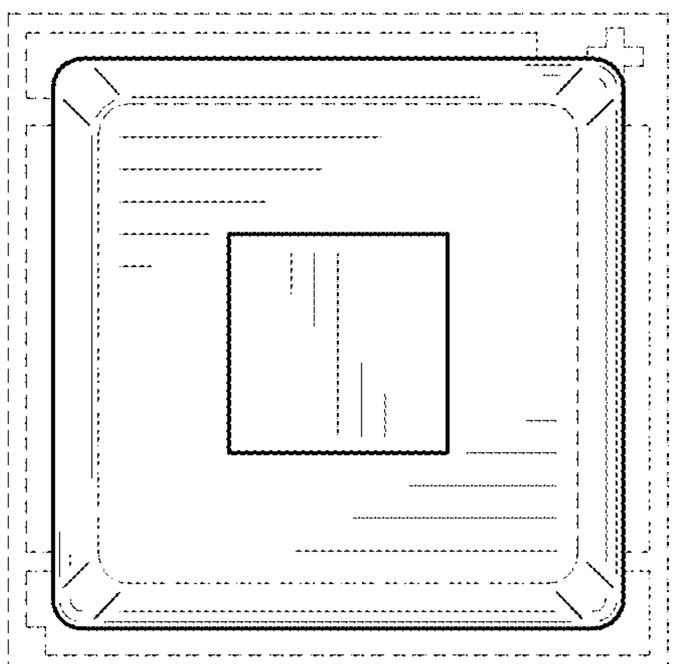


FIG. 6

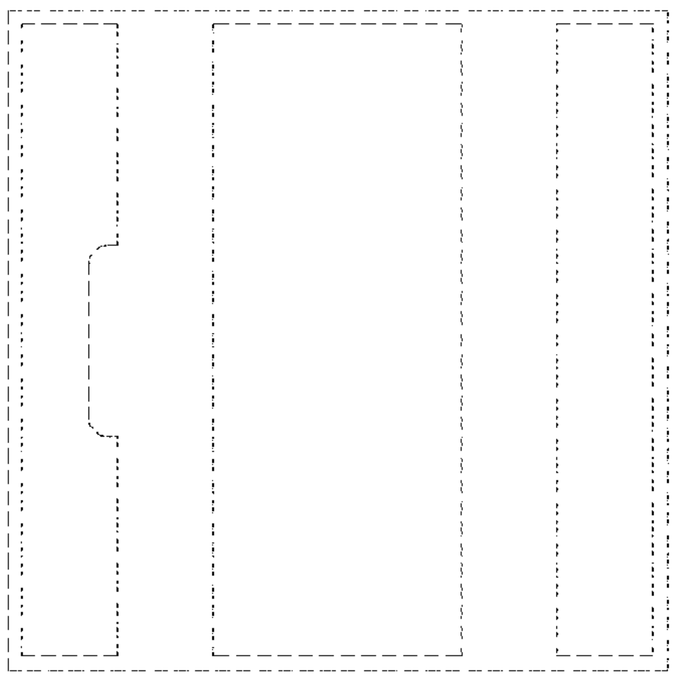


FIG. 7

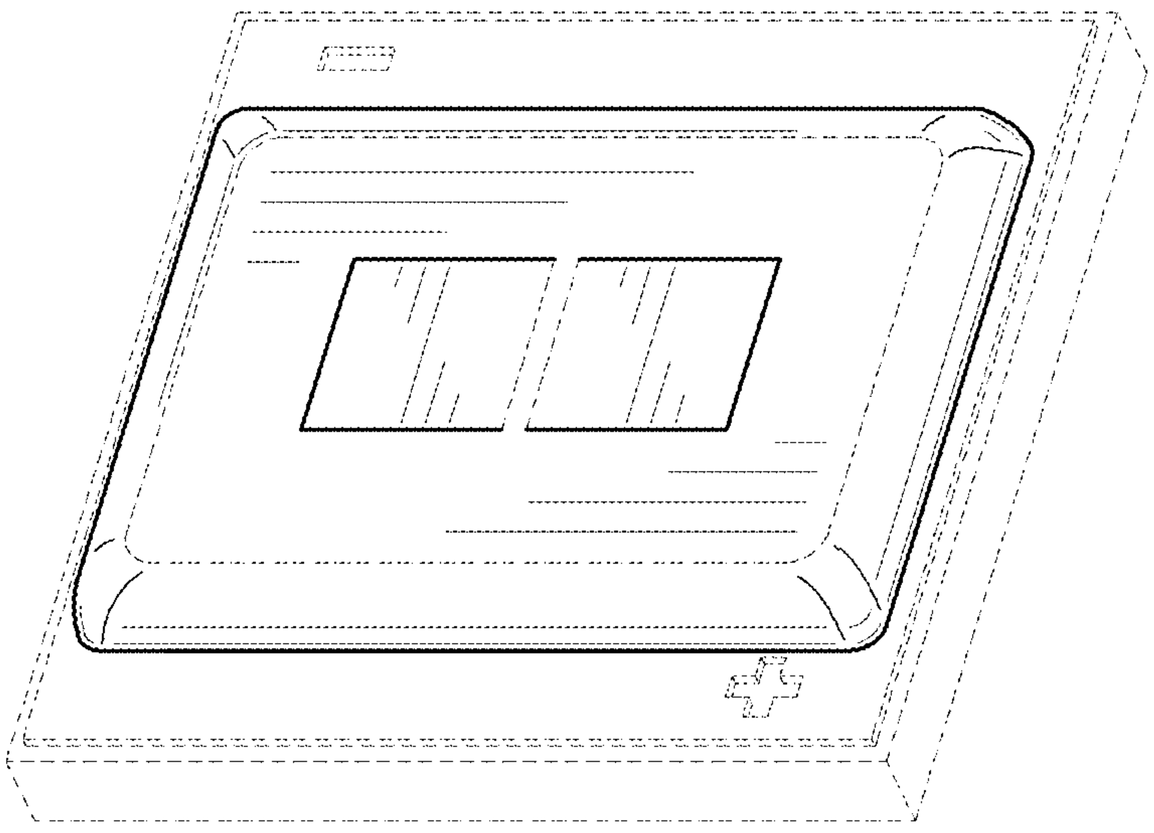


FIG. 8

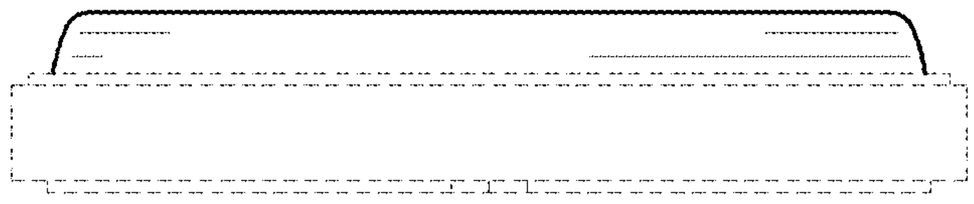


FIG. 9

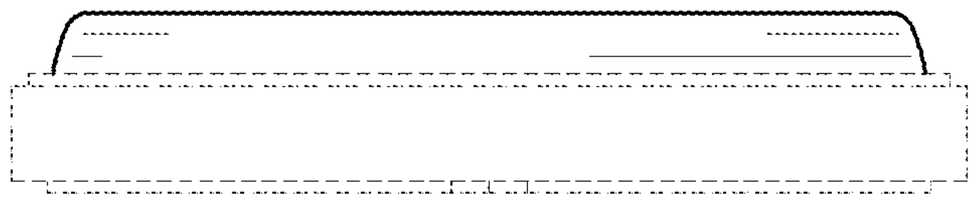


FIG. 10

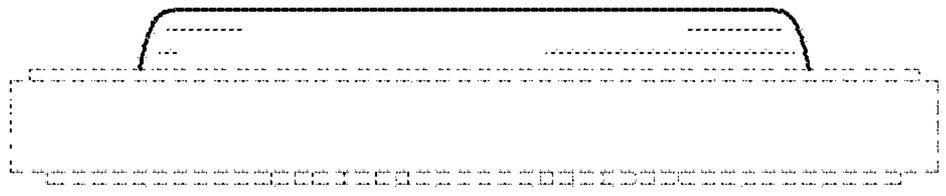


FIG. 11

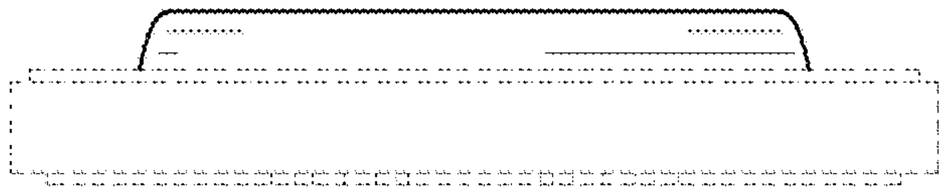


FIG. 12

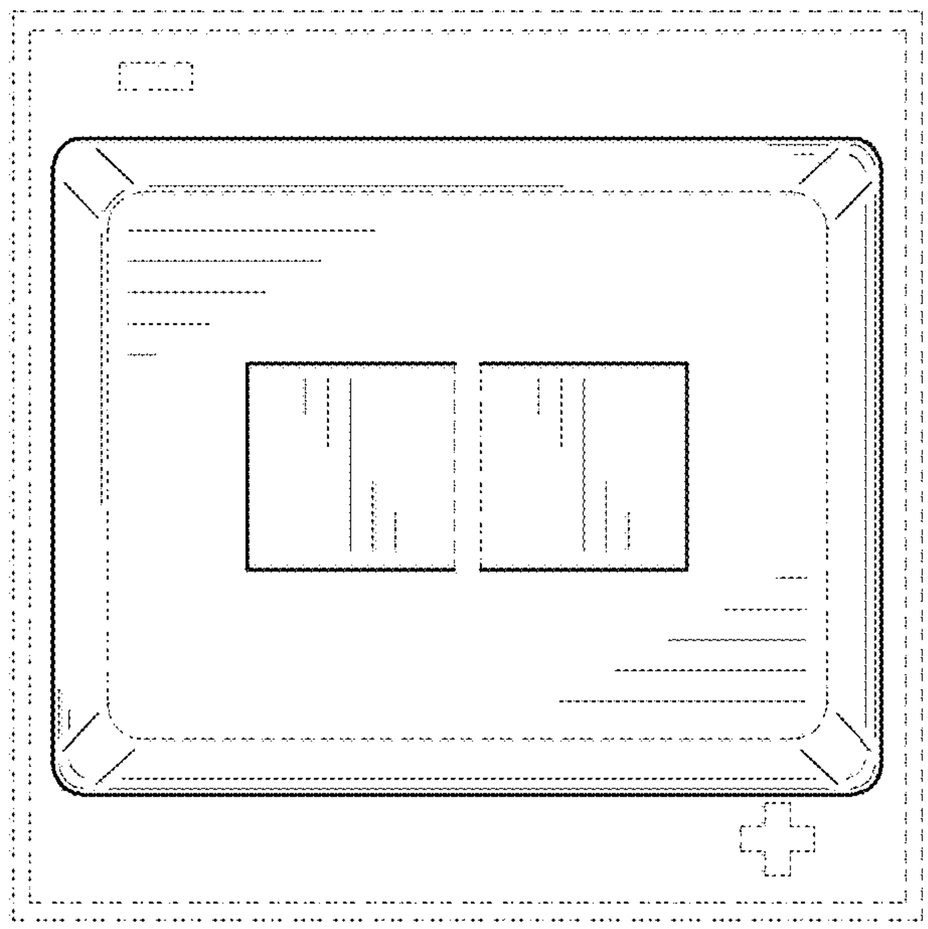


FIG. 13

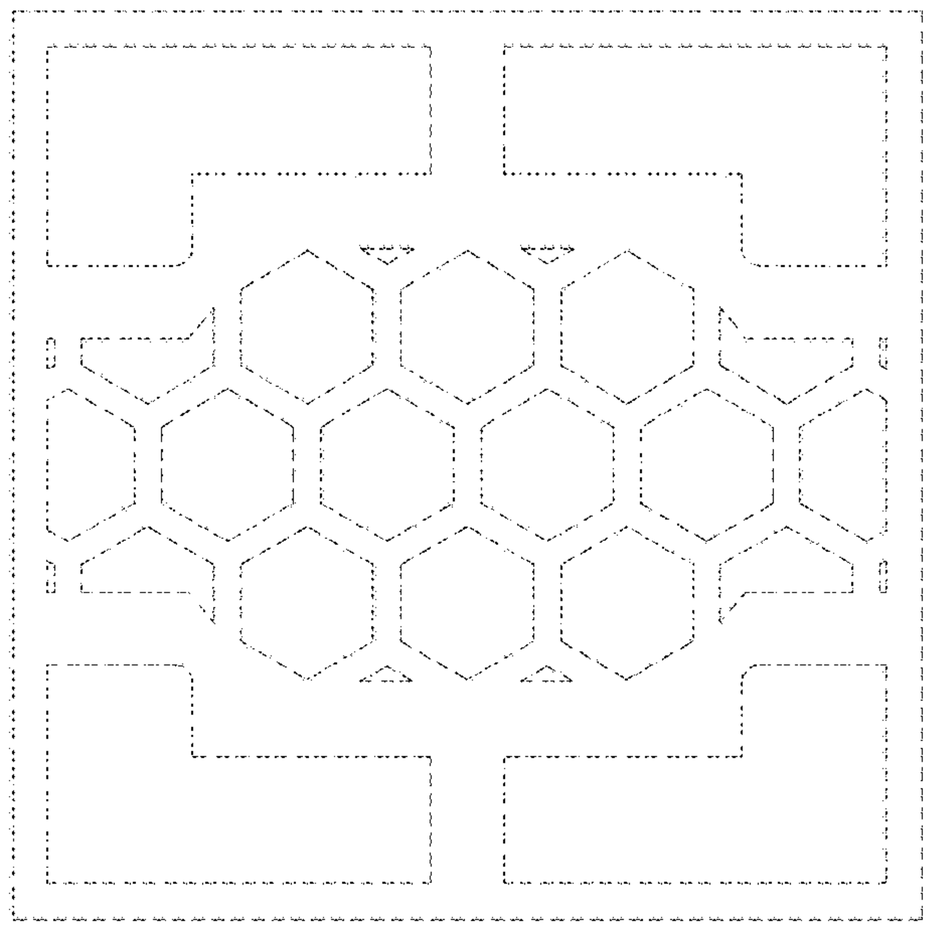


FIG. 14

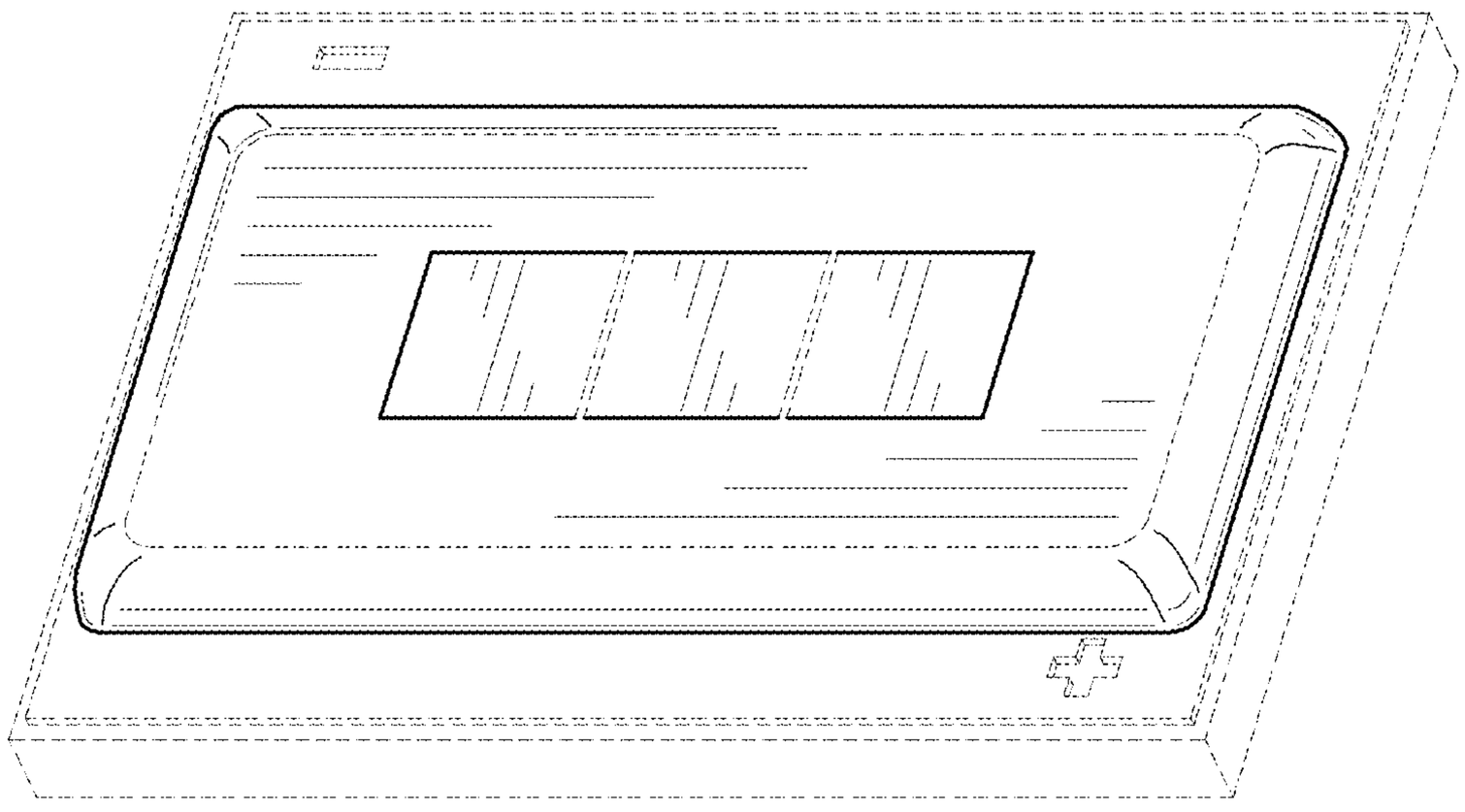


FIG. 15

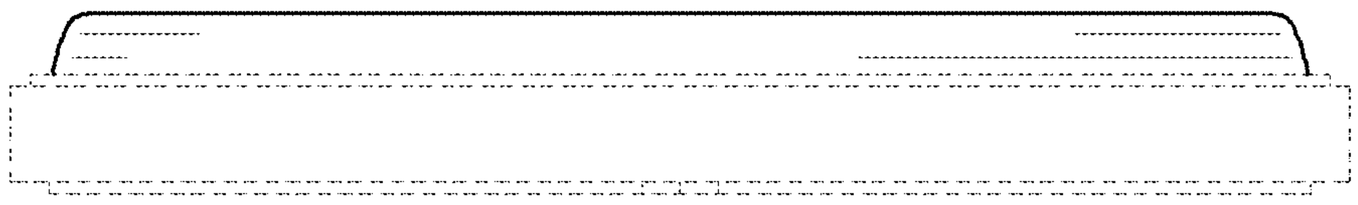


FIG. 16

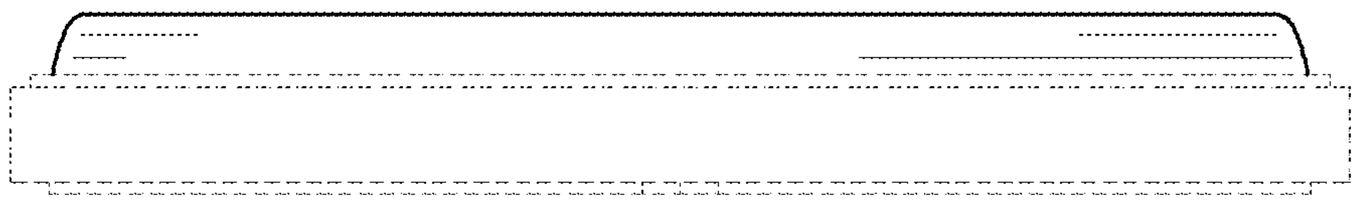


FIG. 17

FIG. 18

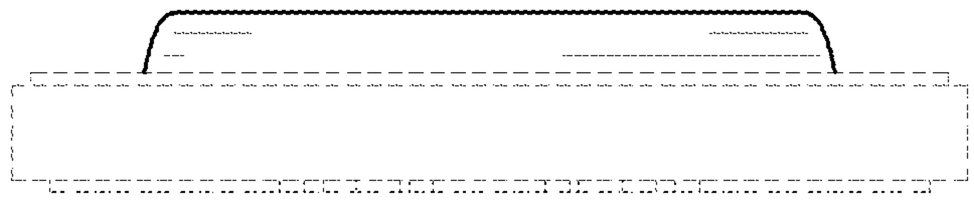


FIG. 19

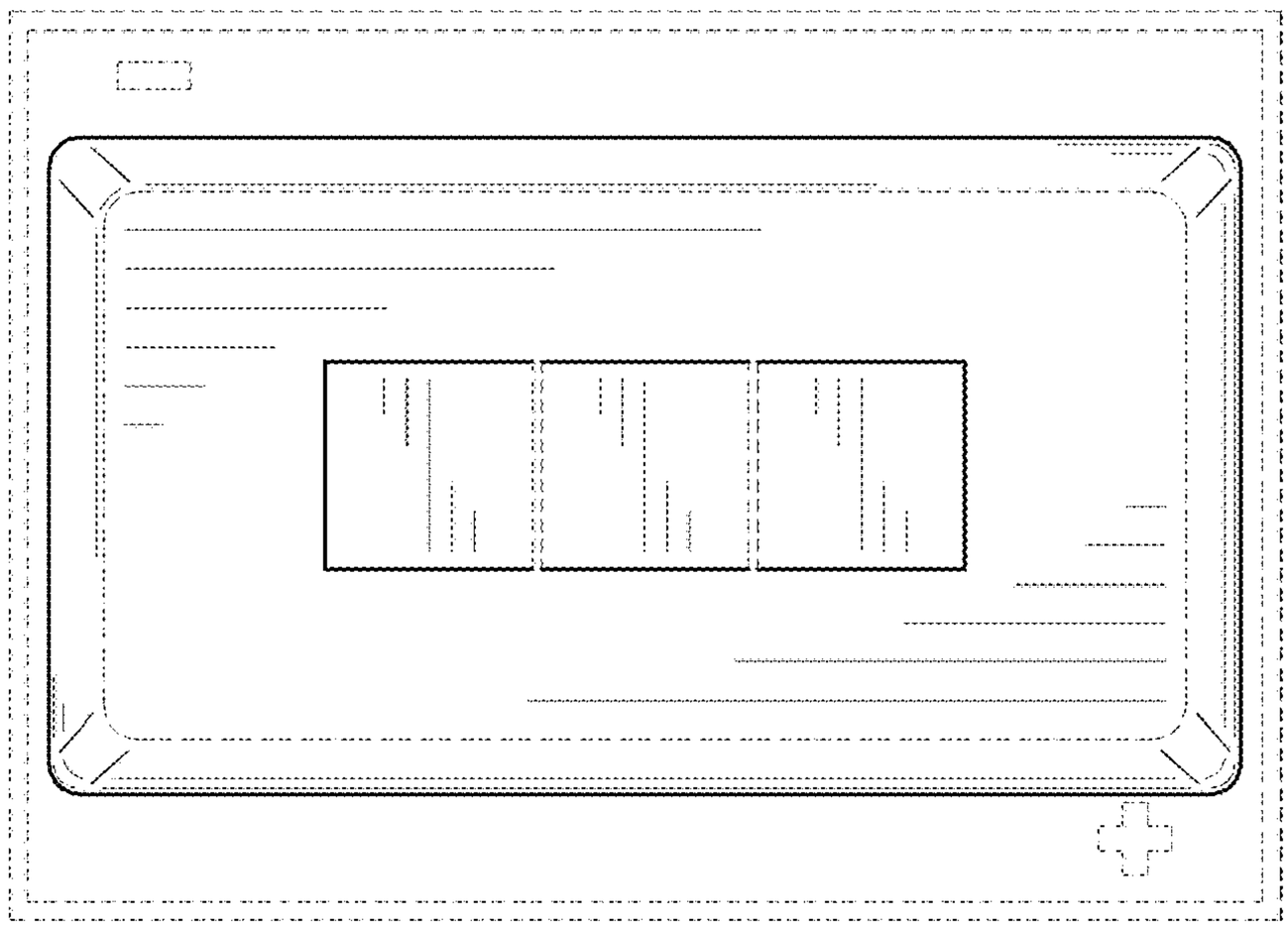


FIG. 20

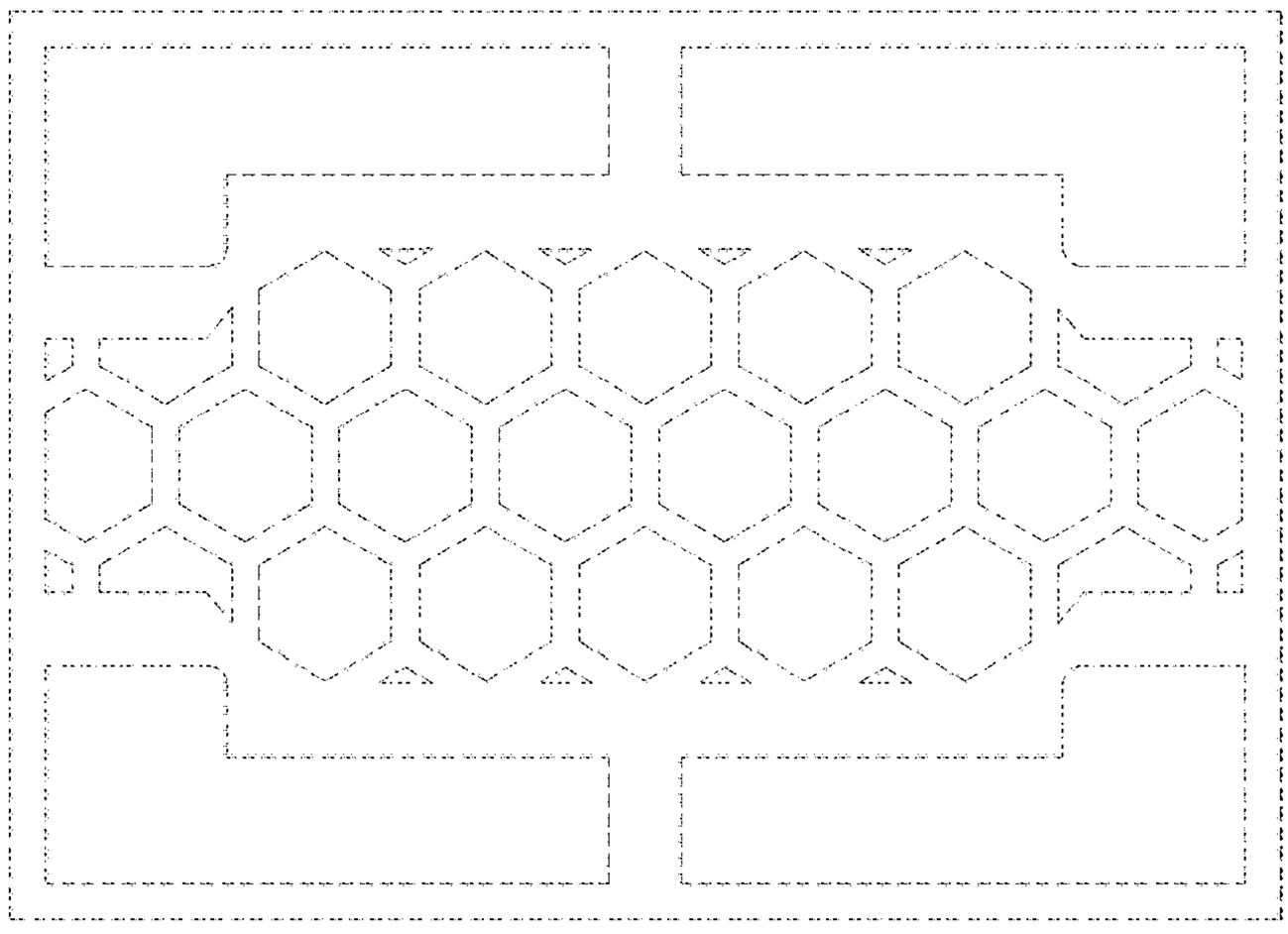


FIG. 21

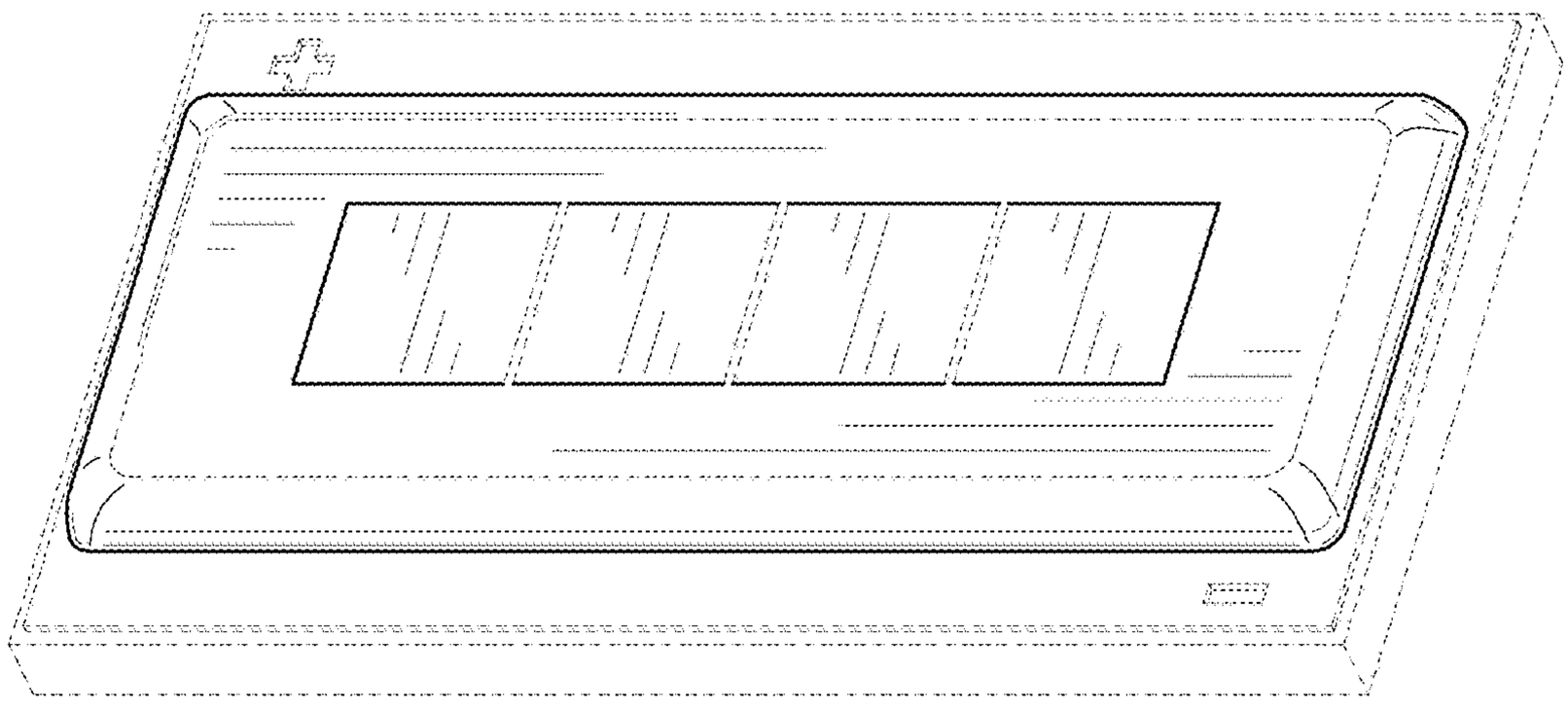


FIG. 22

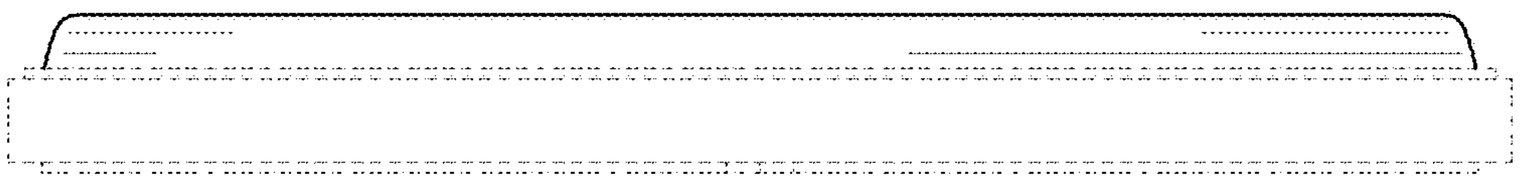


FIG. 23

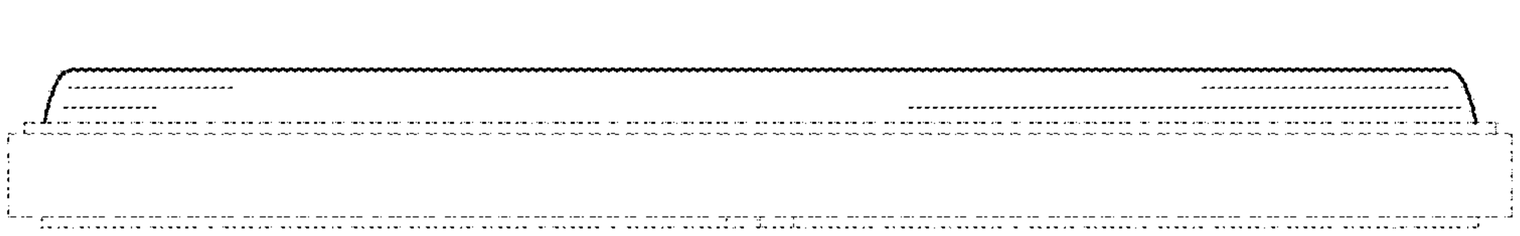


FIG. 24

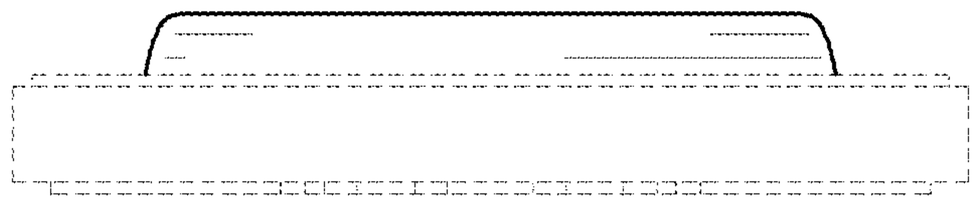


FIG. 25

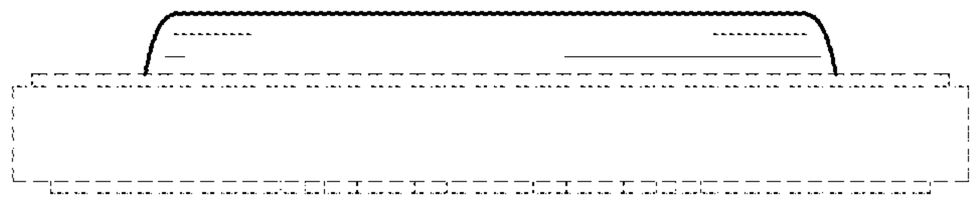


FIG. 26

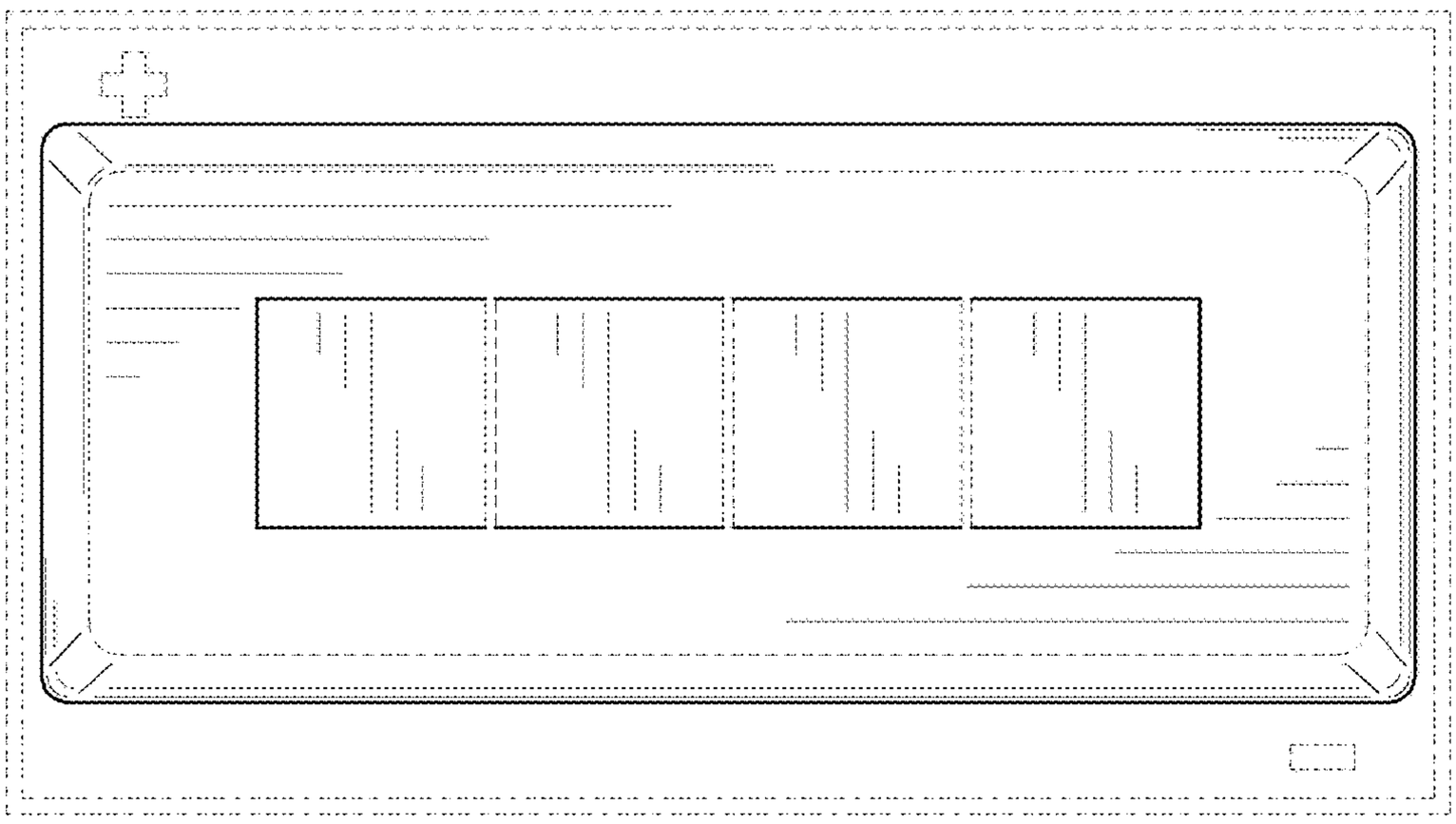


FIG. 27

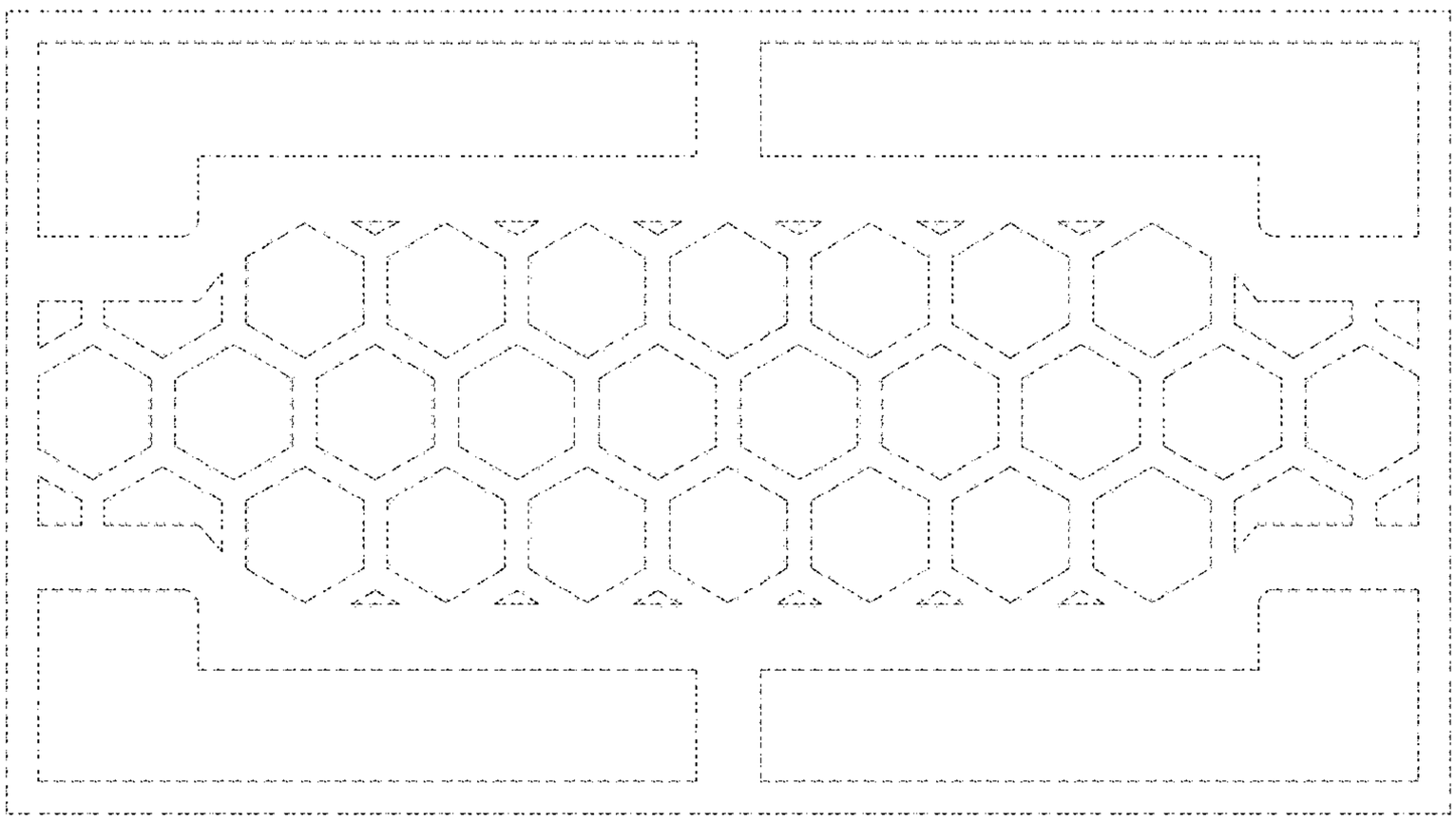
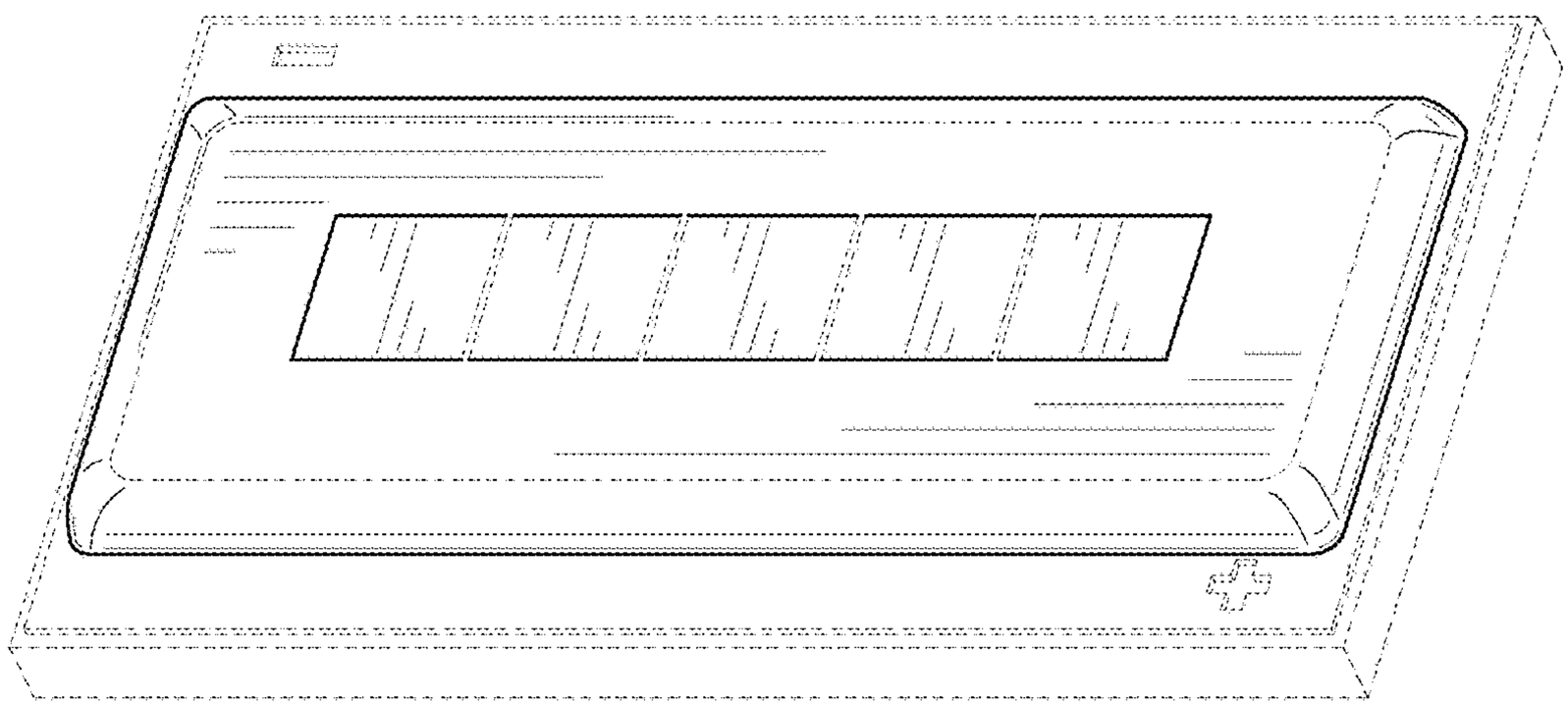


FIG. 28



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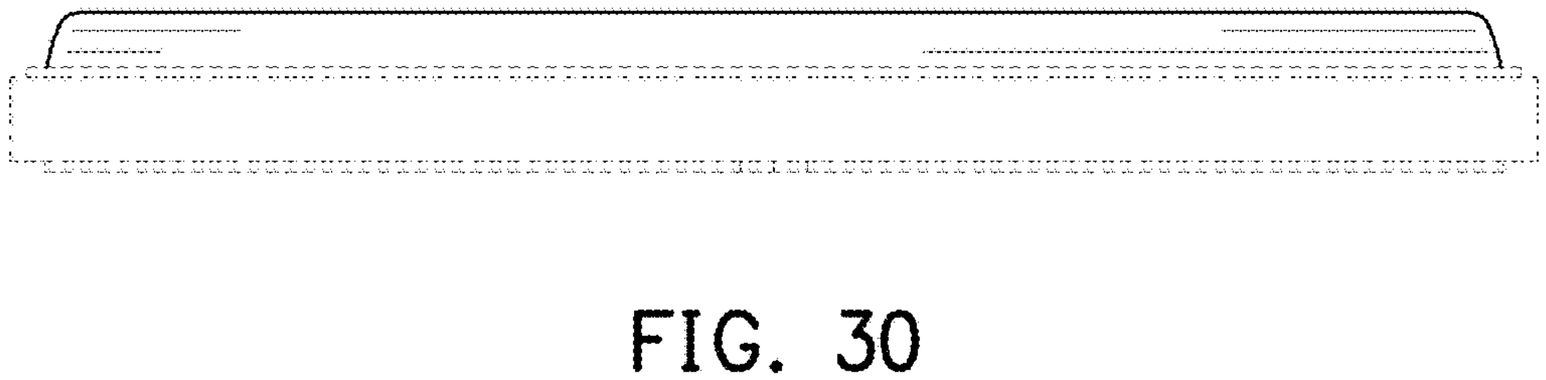
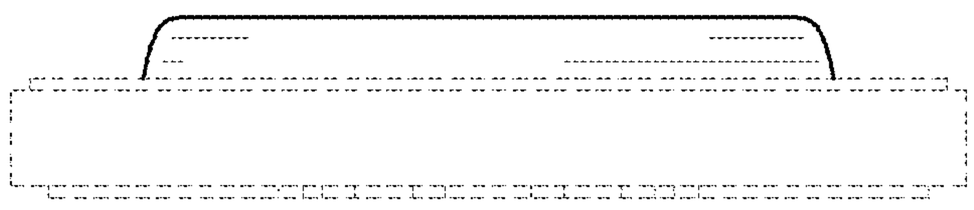


FIG. 30

FIG. 31



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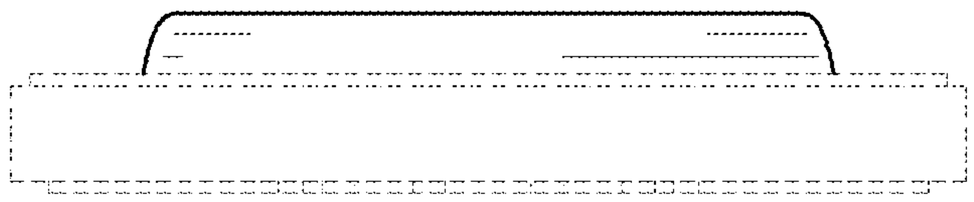

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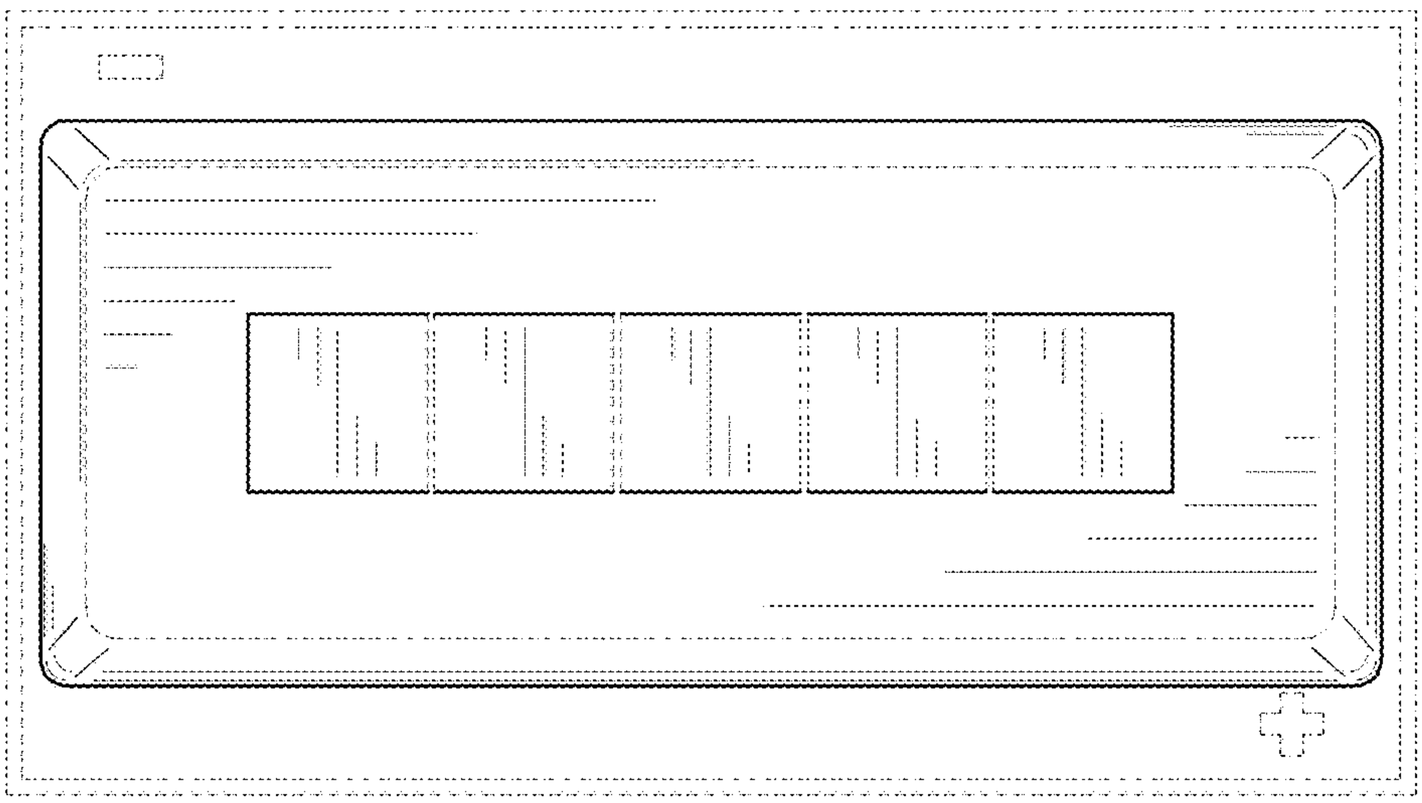

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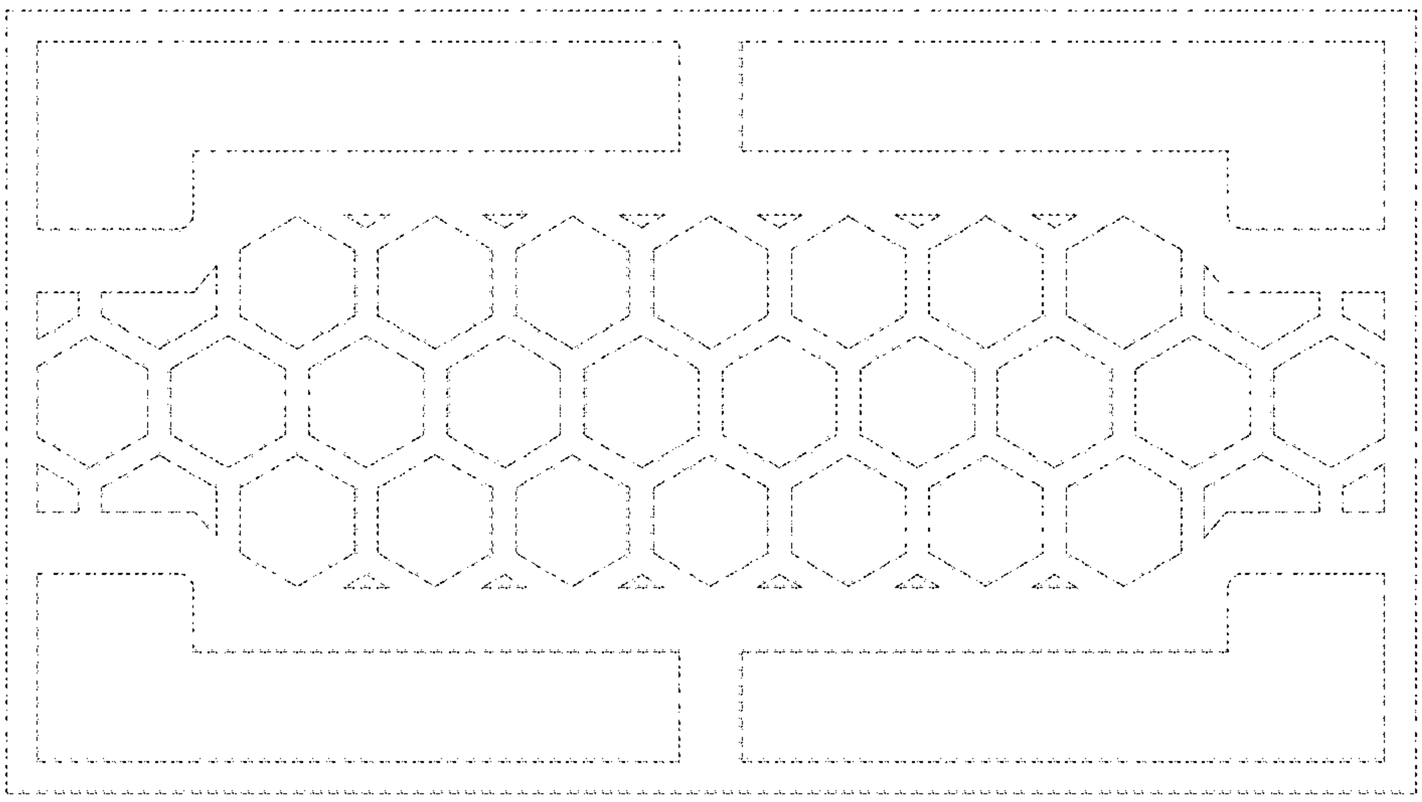

FIG. 35